Topics

- Track 1: Communications and Signal Processing
- Track 2: Wireless Communications and Mobile Networks
- Track 3: Signal Processing and Coding Techniques
- Track 4: Network Architectures and Security

For more information, please visit:
https://www.icecc.org/cfp.html.

Special Session

- Special Session 1: Advances in AI-Generated Image Technologies
- Special Session 2: Advanced Low-Power CMOS Circuits for Energy Harvesting, Time-Domain Processing, Direct Sensing, and Precision Analog Applications
- Special Session 3: AI-Enabled Biomedical Signals and Image Processing for IoT Healthcare Systems
- Special Session 4: Secure and Intelligent 5G/6G-Enabled IoT and Edge Systems
- Special Session 5: Innovations in Optical Sensors, Lasers, Amplifiers and Other Optical Devices
- Special Session 6: Underwater Technologies and Marine IoT
- Special Session 7: AI-Enhanced Digital Forensics and Evidence Recovery for Connected and Cyber-Physical Systems
- Special Session 8: Advanced Sensor Materials, Devices, Circuits, and Systems

Important Dates

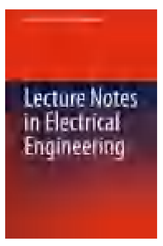
Submission Deadline: December 5, 2026

Notification Deadline: January 5, 2027

Registration Deadline: January 20, 2027

Conference Proceedings

Springer



All full paper submissions will be blind reviewed on the basis of technical quality, relevance to conference topics of interest, originality, significance, presentation and so on. Accepted papers will be published into Lecture Notes in Electrical Engineering (Electronic ISSN: 1876-1119 & Print ISSN: 1876-1100) as a proceedings book volume. The book series will be indexed by EI Compendex, SCOPUS, INSPEC, SCImago and other database.

Keynote Speaker

Prof. Trung Q. Duong
(IEEE Fellow, IET Fellow, CAE Fellow, EIC Fellow, AAIA Fellow)
Memorial University of Newfoundland, Canada

Invited Speaker

Assoc. Prof. Esteve Hassan
Acadia University, Canada

Assoc. Prof. Mohamad Abou Houran
Xi'an Jiaotong University, China

Assoc. Prof. Papis Wongchaisuwat
Kasetsart University, Thailand

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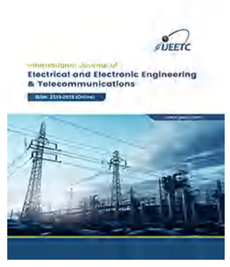
Journal Recommendation



International Journal of Electrical and Electronic Engineering & Telecommunications (IJEETC)
ISSN: 2319-2518 (Online)
CiteScore 2025: 6.9
Abstracting/ Indexing: Scopus (since 2017), Google Scholar, Crossref, etc.

Journal of Communications (JCM)
ISSN: 1796-2021 (Online); 2374-4367 (Print)
CiteScore 2025: 3.8
Abstracting/Indexing: Scopus, DBLP, CrossRef, EBSCO, Google Scholar; CNKI, etc.

International Journal of Mechanical Engineering and Robotics Research (IJMERR)
ISSN: 2278-0149 (Online)
CiteScore 2025: 3.4
Abstracting/Indexing: ESCI (Web of Science), Scopus, CNKI, Google Scholar, Crossref, etc.

Submission

>> Submission Requirements

- Language: English is the official language of the conference; the paper should be written and presented only in English.
- Paper Template.

>> Submission Types

- Abstract submission (200-400words) for presentation only without publication.
- Full paper submission (10-12 pages) for both presentation and publication.

>> Submission Methods

- Submit your paper to Online Submission System: http://confsys.iconf.org/submission/icecc2027.
- Send your paper to email box: icecc.edu@outlook.com.

Contact

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Monday to Friday (GMT+9)

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